

#### **EN 202 Electronics**

#### Welcome

EN 202 Electronics



#### My Introduction

Prof. Rajesh Gupta

Dept. of Energy Science and Engineering

Office: Room No. 3. Near to Energy Sci and Engg. Office

Phone: 7837

Email: rajeshgupta@iitb.ac.in







#### Your Introduction

- Name
- Place
- Background of electronics and electrical
- What you expect from this course





#### Objective of course

To give you a basic background of electronics engineering, which is required for

- Troubleshooting, understanding and making of electrical/electronics circuits/instruments
- Understanding of basic terminology of electronics
- For laboratory experiments
- Minimum electronics knowledge which help in understanding system in which electronics is one of the component



### **Digital Electronics**

EN 202 Electronics



### References

- A.P. Malvino and D.P. Leach, Digital Principles and Applications, Tata McGraw Hill Edition
- W.H. Gothmann, Digital Electronics An Introduction to Theory and Pratice, Prentice Hall of India Private Limited.
- A. P. Malvino, J. A. Brown, Electronics : An Introduction to Microcomputers, Tata Mcgraw Hill.



#### Logic Gates

EN 202 Electronics



### NOT Gate OR Inverter

NOT gate truth table



Input	Output
0	1
1	0

Logic - Opposite of input

**EN 202 Electronics** 



# AND Gate

AND gate



А	В	Output
0	0	0
0	1	0
1	0	0
1	1	1

Logic – output is 0 if there is any input 0

EN 202 Electronics



# OR Gate

OR gate



А	В	Output
0	0	0
0	1	1
1	0	1
1	1	1

Logic – output is 1 if there is any input 1

EN 202 Electronics



### NAND Gate

#### **Universal Gate**

NAND gate



А	В	Output
0	0	1
0	1	1
1	0	1
1	1	0

Logic – output is 1 if there is any input 0

EN 202 Electronics



# NOR Gate

#### **Universal Gate**

NOR gate



	А	В	Output
	0	0	1
Γ	0	1	0
	1	0	0
	1	1	0

Logic – output is 0 if there is any input 1

EN 202 Electronics



# XOR Gate



В

Logic – output is 1 if there are odd number of 1's in input

EN 202 Electronics



# IC's of logic gates





5408/7408 Quad AND gate



5486/7486

5432/7432 Quad OR gate



5404/7404 Hex inverter





#### **EN 202 Electronics**



#### Construct NOT, OR and AND function by NAND Gate







#### Construct NOT, OR and AND function by NOR Gate





# Propose an application based on digital circuit







#### Acceptable input & output voltage

#### TTL – Transistor-Transistor Logic



**EN 202 Electronics** 



## Binary number system

- Why binary number system is required in digital electronics ?
  - Only two states are possible
- Decimal Odometer
  - 000, 001, 002, 003...009, 010, 011..099, 100, 101
- Binary Odometer
  - 000, 001, 010, 011, 100, 101, 110, 111
- Bit = X
- Nibble= XXXX

EN 202 Electronics



# Weight of digits

cimal	Binary
0	0
1	1
2	10
3	11
4	100
5	101
6	110
7	111
8	1000
9	1001
10	1010
11	1011
12	1100
13	1101
14	1110
15	1111
16	10000
17	10001
18	10010
19	10011
20	10100

#### Weigh of digit in decimal system

1206 = 1000 + 200 + 61206 = (1 x 1000) + (2 x 100) + (0 x 10) + (6 x 1)

#### Weight of digit in binary

Convert 110011	to decimal				form:			
bits =	1	1	0	0	1	1	0	1
4	-	-	-	-	-	-	-	-
weight =	1	6	3	1	8	4	2	1
(in decimal	2	4	2	6				
notation)	8							

**EN 202** Electronics

Dε





- A number 7 is required to electrically transmit from one town to another town. What are possible ways ?
- Convert 10101 to decimal
- Convert 55 to binary
  - Successive division





### Binary addition

```
0 + 0 = 0

1 + 0 = 1

0 + 1 = 1

1 + 1 = 10

1 + 1 + 1 = 11
```

#### Examples

	11 1 < Cari	ry bits> 11
1001101	1001001	1000111
+ 0010010	+ 0011001	+ 0010110
1011111	1100010	1011101

EN 202 Electronics



# **Binary subtraction**

0-0=0 1-0=1 1-1=0 10-1=1 Examples 407 100 (4) 1101 (13) 11001000 -328 -001 (1) -1010 (10) -01001011 -----079 011 (3) 0011 (3) 01111101



#### **Binary Adder**

EN 202 Electronics



# Half Adder







# Full Adder





EN 202 Electronics



# Boolean ArithmeticBased on logic gate





### OR and AND operation













1 + 1 = 1





 $0 \times 0 = 0$ 



 $0 \times 1 = 0$ 







 $1 \times 1 = 1$ 



Y = A.B

**EN 202** Electronics



#### NOT, NAND and NOR NOT • $Y = \overline{A}$ NAND • $Y = \overline{AB}$ NOR • Y = A + BXOR • Y = ??

**EN 202 Electronics** 



#### Basics of boolean algebra

Additive				ve		Multiplicative
	А	+	0	=	А	0A = 0
	A	+	1	=	1	1A = A
	Α	+	Α	=	А	AA = A
	А	+	Ā	=	1	$A\overline{A} = 0$

Additi	ve	Multiplicative
A + B =	B + A	AB = BA
A + (B + C)	= (A + B) + C	A(BC) = (AB)C
	A(B + C) = AB	+ AC

EN 202 Electronics



#### Boolean rules for simplification



EN 202



# Contd.

• A+BC=(A+B)(A+C)





Useful Boolean rules for simplification

$$A + AB = A$$
  
 $A + \overline{AB} = A + B$   
 $(A + B)(A + C) = A + BC$ 

**EN 202 Electronics** 



### Circuit simplification example



AB + BC (B + C)  $\downarrow Distributing terms$  AB + BBC + BCC  $\downarrow Applying identity AA = A$   $\downarrow to 2nd and 3rd terms$  AB + BC + BC  $\downarrow Applying identity A + A = A$   $\downarrow to 2nd and 3rd terms$  AB + BC  $\downarrow Factoring B out of terms$  B (A + C)

Realize with less number of gates

**EN 202 Electronics** 



### DeMorgan's Theorems



**EN 202 Electronics** 



Solve



• Ans  $A\overline{B}$ 

EN 202 Electronics



#### $\overline{AB} + \overline{A} + AB + = 0$ $\overline{AB} + \overline{AC} + \overline{ABC}(AB + C) = 1$

EN 202 Electronics
# Converting truth tables into Boole and expressions

#### Sum of product approach



#### Ans AB+BC+CA

EN 202 Electronics



#### Product-Of-Sums approach









#### Logic simplification with Karnaugh maps





Out =  $\overline{ABC} + ABC$   $A \xrightarrow{BC} 00 011110$  0 1 1 1 1 1Out = BC Out =  $\overline{ABC} + \overline{ABC} + \overline{ABC} + \overline{ABC} + \overline{ABC}$   $A \xrightarrow{BC} 00 011110$   $0 \xrightarrow{1} 1 1 1 1$   $1 \xrightarrow{1} 000$ Out =  $\overline{A}$ 





Out= B



 $Out = \overline{A} + B$ 



EN 202 Electronics







#### Larger 4-variable Karnaugh maps



 $\texttt{Out} = \overline{\texttt{ABCD}} + \overline{\texttt{ABC$ 



 $Out = \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD}$ 



 $\begin{array}{r} \text{Out} = \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} \\ + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} \end{array}$ 



**EN 202** Electronics





#### $Out = \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD} + \overline{ABCD}$







#### EN 202 Electronics







Simplification by Boolean Algebra

 $Out = \overline{C} + ABCD$ 

Applying rule  $\mathbf{A} + \overline{\mathbf{A}}\mathbf{B} = \mathbf{A} + \mathbf{B}$  to the  $\overline{\mathbf{C}}$  + ABCD term

 $Out = \overline{C} + ABD$ 

**EN 202 Electronics** 



#### Sigma Notation

Out=	<u>ABCD</u>	+	<u>A</u> B <u>C</u> D	+	<u>A</u> BCD
+	ABCD	+	ABCD	+	ABCD
+	ABCD	+	ABCD	$^+$	ABCD

 $f(A,B,C,D) = \sum m(0,1,3,4,5,7,12,13,15)$ 



$$f(A,B,C,D) = \overline{AC} + \overline{AD} + \overline{BC} + \overline{BD}$$



#### **Pi-Notation**

 $f(A,B,C,D) = \Pi M(2,6,8,9,10,11,14)$ 



 $f(A,B,C,D) = \overline{(A+B)}(\overline{C}+D)$ 

**EN 202 Electronics** 



#### Don't Care cells in the Karnaugh map

L3 BC A 00

0 0

1

L3 = A + BC

01 11 10

0

0



**EN 202 Electronics** 



### Problem

 $f = \Sigma m (0,1,3,4,5,7,10,13)$   $f = \Sigma m (1,2,3,5,6,7,8,12,13)$  $f = \Sigma m (0,2,6,10,11,12,13) + d(3,4,5,14,15)$ 





#### **FLIP-FLOP**

EN 202 Electronics



#### Sequential logic

Sequential logic, unlike combinational logic is not only affected by the present inputs, but also, by the prior history



#### R-S Flip-flop or R-S latch



S	R	Q	$\overline{Q}$
0	0	latch	latch
0	1	0	1
1	0	1	0
1	1	0	0



**EN 202 Electronics** 



#### Gated S-R latch



Е	S	R	Q	Q
0	0	0	latch	latch
0	0	1	latch	latch
0	1	0	latch	latch
0	1	1	latch	latch
1	0	0	latch	latch
1	0	1	0	1
1	1	0	1	0
1	1	1	0	0





### D Flip-flop OR D latch



Е	D	Q	$\overline{Q}$
0	0	latch	latch
0	1	latch	latch
1	0	0	1
1	1	1	0







#### D Flip-Flop Response



**EN 202 Electronics** 



#### Edge-triggered Response



Positive edge-triggered D-latch response

Negative edge-triggered D-latch response



Outputs respond to input (D) only when enable signal transitions from high to low



### Edge trigger realization





### Edge triggered RS flip-flop



C	S	R	Q	Q
5	0	0	latch	latch
L	0	1	0	1
L	1	0	1	0
Г	1	1	0	0
х	0	0	latch	latch
х	0	1	latch	latch
х	1	0	latch	latch
х	1	1	latch	latch





### J-K flip-flop



С	J	К	Q	Q
Г	0	0	latch	latch
Г	0	1	0	1
Г	1	0	1	0
Г	1	1	toggle	toggle
х	0	0	latch	latch
x	0	1	latch	latch
х	1	0	latch	latch
х	1	1	latch	latch



EN 202 Electronics



#### Preset and Clear in flip-flop







EN 202 Electronics



#### Counters

EN 202 Electronics



#### Asynchronous counters





EN 202 Electronics











#### Up and Down counter

A simultaneous "up" and "down" counter







**EN 202 Electronics** 



#### Propagation delay in asynchronous counter



Pulse diagram showing (exaggerated) propagation delays



EN 202 Electronics



#### Synchronous counters



EN 202 Electronics





A four-bit synchronous "down" counter

EN 202 Electronics



#### Application of counter



**EN 202 Electronics** 



### Problem

#### Application of counters ?

EN 202 Electronics



#### Shift Register

EN 202 Electronics



## Application

- Shift registers produce a discrete delay of a digital signal or waveform
- Very long shift registers served as digital memory





#### Shift Register Types

- Serial-in/serial-out
- Serial-in/parallel-out
- Parallel-in/serial-out
- Parallel-in/parallel-out
- Ring counter

**EN 202 Electronics**


## Serial-in/serial-out



EN 202 Electronics



#### Parallel-in/serial-out



Parallel-in, serial-out shift register with 4 stages





## Serial-in/parallel-out



Serial-in, parallel-out shift register with 4 stages

EN 202 Electronics



#### Parallel-in/Parallel-out



Parallel-in, parallel-out shift register with 4 stages

EN 202 Electronics



## Ring counter



Ring Counter, shift register output fed back to the input







#### Serial-in, Serial-out shift register



Serial-in, serial-out shift register using type "D" storage elements



Serial-in, serial-out shift register using type "JK" storage elements







## Parallel-in serial out



Parallel-in/ serial-out shift register showing parallel load path



Parallel-in/ serial-out shift register showing shift path



EN 202 Electronics



## Serial-in/parallel out



Serial-in/ parallel-out shift register waveforms

EN 202 Electronics



# Problem

Parallel-in parallel-out circuit ?

EN 202 Electronics



## Ring counter



EN 202 Electronics

EN 202 Electronics

Rajesh Gupta

#### **Digital Storage**





# Why digital ?

- The basic goal of digital memory is to provide a means to store binary data: sequences of 1's and 0's
- The most evident advantage of digital data storage is the resistance to corruption
  - Magnetization method of storage
- Digital data storage also complements digital computation technology



#### Random access and sequential access

- Random access means that you can quickly and precisely address a specific data location within the device, and non-random (sequential) simply means that you cannot
  - that you cannot
- Examples
  - A vinyl record platter is an example of a random-access device (CD's also)
  - Cassette tape is sequential



#### Writing and Reading

- The process of storing a piece of data to a memory device is called *writing*
- The process of retrieving data is called *reading*
- ROM (read only memory)- Some devices do not allow for the writing of new data, and are purchased "prewritten".
  - Example: vinyl records
- Read-write memory Memories allow reading and writing
  - Example: Cassette audio and video tape

EN 202 Electronics



#### Memory with moving parts: "Drives"

- Paper tape
- Magnetic tape (sequential access, slow)
- Magnetic storage drives drum type (motor, R/W coil)
- Floppy disk (not reliable)
- Hard drive
- Compact disk (CD)
  - Binary bits are "burned" into the aluminum as pits by a highpower laser
- Digital Video Disk (DVD)





#### Modern nonmechanical memory

 A very simple type of electronic memory is flip-flop









### **ROM-Read-only memory**

 PROMs - Programmable Read-Only Memory

The simplest type of ROM is that which uses tiny "fuses" which can be selectively blown or left alone to represent the two binary states

- EPROM Erasable Programmable Read-Only Memory
  - Electrically-erasable (EEPROM)
  - Ultraviolet-erasable (UV/EPROM)







#### Volatile and non-volatile memory

- Volatile memory loose its data when power goes off (e.g, RAM of computer)
- Non Volatile memory retain data even without power (e.g. ROM, magnetic tapes)





## Memory Address

- The location of this data within the storage device is typically called the *address*, in a manner reminiscent of the postal service.
  - the address in which certain data is stored can be called up by means of parallel data lines in a digital circuit
  - data is addressed in terms of an actual physical location on the surface of some type of media (e.g. *tracks* and *sectors* of circular computer disks)



## Memory Array

For more storage, many latches arranged in a form of array where we can selectively address which one is reading from or writing to.





## Memory Size

- Number of bits
- Generally memory size represented in bytes
  (1 byte = 8 bits)
  - Example
    - 1.6 Gigabytes = 12.8 Giga bits
  - "One kilobyte" = 1024 bytes (2 to the power of 10) locations for data bytes (rather than exactly 1000)
  - "64 kbyte" memory device actually holds 65,536 bytes of data (2 to the 16th power)



## **Digital computer**

Main components

- CPU: central procession unit
- Memory
- Input output device



**EN 202 Electronics** 



## Microprocessor or CPU

- It fatches instruction from the memory and performs specified tasks.
- It store results in the memory or sends results to the output device
- It control with memory and input/output devices





# Sections of CPU

- Arithmetic and logic unit to perform arithmetic operations such as addition and subtractions, logical operation (AND,OR, etc.)
- Timing and control unit control entire operation of a computer. It acts as a brain. It also control all other devices connected to CPU
- General purpose registers for temporary storage of data and intermediate results while computer is making execution of program
- Accumulator It is a register which contain one the operands and store results of most arithmetic and logical operations



## Electrical Theorem and Components





### **Thevenin's Theorem**

 Thevenin's Theorem is a way to reduce a network to an equivalent circuit composed of a single voltage source, series resistance, and series load



 Useful in analyzing power systems and other circuits where one particular resistor in the circuit (called the "load" resistor) is subject to change, and recalculation of the circuit is necessary with each trial value of load resistance, to determine voltage across it and current through it.





#### Steps to follow for Thevenin's Theorem

 Find the Thevenin source voltage by removing the load resistor from the original circuit and calculating voltage across the open connection points where the load resistor used to be.

Designate R2 as the "load" resistor

Determining voltage and current across R2

**EN 202 Electronics** 





	R <sub>1</sub>	R <sub>3</sub>	Total	
Е	16.8	4.2	21	Volts
Т	4.2	4.2	4.2	Amps
R	4	1	5	Ohms





EN 202 Electronics



 Find the Thevenin resistance by removing all power sources in the original circuit (voltage sources shorted and current sources open) and calculating total resistance between the open connection points.







- 3. Draw the Thevenin equivalent circuit, with the Thevenin voltage source in series with the Thevenin resistance. The load resistor re-attaches between the two open points of the equivalent circuit.
- 4. Analyze voltage and current for the load resistor following the rules for series circuits.





### Norton's Theorem

- Norton's Theorem is a way to reduce a network to an equivalent circuit composed of a single current source, parallel resistance, and parallel load.
- Useful in analyzing power systems and other circuits where one particular resistor in the circuit (called the "load" resistor) is subject to change, and recalculation of the circuit is necessary with each trial value of load resistance, to determine voltage across it and current through it.







#### Steps to follow for Norton's Theorem

 Find the Norton source current by removing the load resistor from the original circuit and calculating current through a short (wire) jumping across the open connection points where the load resistor used to be



R<sub>1</sub>

R<sub>1</sub>

Designate R2 as the "load" resistor

Determining voltage and current across R2







EN 202 Electronics



 Find the Norton resistance by removing all power sources in the original circuit (voltage sources shorted and current sources open) and calculating total resistance between the open connection points.





- Draw the Norton equivalent circuit, with the Norton current source in parallel with the Norton resistance. The load resistor re-attaches between the two open points of the equivalent circuit.
- 4. Analyze voltage and current for the load resistor following the rules for parallel circuits.



2

R

0.8

Ohms

571.43m



#### **Thevenin-Norton equivalencies**

#### Thevenin Equivalent Circuit



Norton Equivalent Circuit



 $\mathbf{R}_{\mathrm{Thevenin}} = \mathbf{R}_{\mathrm{Norton}}$ 

$$\mathbf{E}_{\mathrm{Thevenin}} = \mathbf{I}_{\mathrm{Norton}} \mathbf{R}_{\mathrm{Norton}}$$



**EN 202** Electronics


#### **Electrical Components**







#### Capacitor

- The ability of a capacitor to store energy in the form of an electric field is called *capacitance*. It is measured in the unit of the *Farad* (F).
- Capacitors used to be commonly known by another term: condenser.
- Capacitors react against changes in voltage.
- When a capacitor is faced with an increasing voltage, it acts as a *load*: drawing current as it absorbs energy.
- When a capacitor is faced with a decreasing voltage, it acts as a source: supplying current as it releases stored energy.



#### Capacitors and calculus

 $i = C \frac{dv}{dt}$ 

Where,

i = Instantaneous current through the capacitor

C = Capacitance in Farads



Capacitor voltage

 $E_{c}$ 

EN 202 Electronics



#### Contd.









EN 202 Electronics



EN 202 Electronics





#### Factors affecting capacitance



Where,

- C = Capacitance in Farads
- ε = Permittivity of dielectric (absolute, not relative)
- A = Area of plate overlap in square meters
- d = Distance between plates in meters

- PLATE AREA
- PLATE SPACING
- DIELECTRIC
  MATERIAL



**EN 202 Electronics** 



#### Series and parallel capacitors





$$\mathbf{C}_{\text{total}} = \mathbf{C}_1 + \mathbf{C}_2 + \dots \mathbf{C}_n$$





EN 202 Electronics



#### Practical considerations

- Working voltage
- Polarity
- Equivalent circuit
- Physical Size



#### Capacitor equivalent circuit





EN 202 Electronics



#### Inductors

- The ability of an inductor to store energy in the form of a magnetic field is called *inductance*. It is measured in the unit of the *Henry* (H).
- Inductors used to be commonly known by another term: *choke*.
  In large power applications, they are sometimes referred to as *reactors*.
- Inductors react against changes in current by dropping voltage in the polarity necessary to oppose the change.
- When an inductor is faced with an increasing current, it acts as a load
- When an inductor is faced with a decreasing current, it acts as a source



#### Inductors and calculus

"Ohm's Law" for an inductor



**EN 202 Electronics** 



## Contd.

Potentiometer wiper moving slowly in the "up" direction





EN 202 Electronics





Potentiometer wiper moving in the "down" direction



EN 202 Electronics



#### Factors affecting inductance



Where,

- L = Inductance of coil in Henrys
- N = Number of turns in wire coil (straight wire = 1)
- $\mu$  = Permeability of core material (absolute, not relative)
- A = Area of coil in square meters
- 1 = Average length of coil in meters



- TURNS IN THE COIL
- COIL AREA
- COIL LENGTH
- CORE MATERIAL







#### Series and parallel inductors

Series Inductances

 $\mathbf{L}_{\text{total}} = \mathbf{L}_1 + \mathbf{L}_2 + \dots + \mathbf{L}_n$ 

Parallel Inductances

$$\mathbf{L}_{\text{total}} = \frac{1}{\frac{1}{\mathbf{L}_1} + \frac{1}{\mathbf{L}_2} + \dots + \frac{1}{\mathbf{L}_n}}$$





### Practical considerations

- Rated current
- Equivalent circuit
- Inductor size
- Interference



### **Analog Electronics**

EN 202 Electronics



#### References

- A.P. Malvino, Eletronic Principles, Tata McGraw-Hill Publishing Company Limited, New Delhi
- N.N. Bhargava, D.C. Kulshreshtha, S.C. Gupta,
  Basic Electronics and Linear Circuits, Tata
  McGraw-Hill Publishing Company Limited, New Delhi



EN 202 Electronics



#### n-type semiconductor





#### Legends :

- Free electron (Negative Charge)
- Hole (Positive Charge)
- Immobile ion (Positive Charge)

EN 202 Electronics



### p-type semiconductor





#### Legends :

- Hole (Positive Charge)
- Electron (Negative Charge)
- $\Theta$  Immobile ion (Negative Charge)

EN 202 Electronics



# p-n junction

P - type	<b>N</b> - type	P - type Electric field N - type
	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{c} \bigcirc & \bigcirc $
	۰J	Cepletion region



#### p-n junction forward biased



**EN 202** Electronics



#### p-n junction reverse biased



**EN 202 Electronics** 



### Introduction





EN 202 Electronics



$$I_D = I_S \left( e^{\frac{qV}{NkT}} - 1 \right)$$

 $I_D$  diode current

 $I_s$  ----- saturation current

q ----- Charge of electron(1.6  $\bullet$  10<sup>-19</sup> As)

V Voltage across the diode

N -----"Non-ideality" coefficient(typ.between 1 and 2)

k ----- Boltzmann's constant (1.38) •10<sup>-23</sup>)

T ----- Junction temperature in kelvin

$$I_D = I_S (e^{V_D / 0.026} - 1)$$





## Example



EN 202 Electronics



## Summary

- A *diode* is an electrical component acting as a one-way valve for current.
- When voltage is applied across a diode in such a way that the diode allows current, the diode is said to be *forward-biased*.
- When voltage is applied across a diode in such a way that the diode prohibits current, the diode is said to be *reverse-biased*.
- The voltage dropped across a conducting, forward-biased diode is called the *forward voltage*. Forward voltage for a diode varies only slightly for changes in forward current and temperature, and is fixed principally by the chemical composition of the P-N junction.
- Silicon diodes have a forward voltage of approximately 0.7 volts.
- Germanium diodes have a forward voltage of approximately 0.3 volts.
- The maximum reverse-bias voltage that a diode can withstand without "breaking down" is called the *Peak Inverse Voltage*, or *PIV* rating.



#### Meter check of a diode

- Connected one way across the diode, the meter should show a very low resistance.
- Connected the other way across the diode, it should show a very high resistance ("OL" on some digital meter models)





## Problem

Find out Application of Diodes

EN 202 Electronics



### **Rectifier Circuits**

*Rectification* is the conversion of alternating current (AC) to direct current (DC).

- A half-wave rectifier is a circuit that allows only one half-cycle of the AC voltage waveform to be applied to the load, resulting in one non-alternating polarity across it. The resulting DC delivered to the load "pulsates" significantly.
- A *full-wave* rectifier is a circuit that converts both half-cycles of the AC voltage waveform to an unbroken series of voltage pulses of the same polarity. The resulting DC delivered to the load doesn't "pulsate" as much.



### Half-wave Rectifier





EN 202 Electronics



### **Full-wave Rectifier**







EN 202 Electronics



#### Full wave bridge rectifier





EN 202 Electronics



## **Diode ratings**

In addition to forward voltage drop (Vf) and peak inverse voltage (PIV), there are many other ratings of diodes

- Maximum DC reverse voltage = V<sub>R</sub> or V<sub>DC</sub> The maximum amount of voltage the diode can withstand in reverse-bias mode on a continual basis. Ideally, this figure would be infinite.
- Maximum reverse current =  $I_R$  the amount of current through the diode in *reverse-bias* operation, with the maximum rated inverse voltage applied ( $V_{DC}$ ). Sometimes referred to as *leakage current*. Ideally, this figure would be zero, as a perfect diode would block all current when reverse-biased. In reality, it is very small compared to the maximum forward current.



## Contd.

- Maximum (average) forward current = I<sub>F(AV)</sub> The maximum average amount of current the diode is able to conduct in forward bias mode. *This is fundamentally a thermal limitation*: how much heat can the PN junction handle, given that dissipation power is equal to current (I) multiplied by voltage (V or E) and forward voltage is dependent upon both current and junction temperature. Ideally, this figure would be infinite.
- Maximum (peak or surge) forward current = I<sub>FSM</sub> or i<sub>f(surge)</sub> The maximum peak amount of current the diode is able to conduct in forward bias mode. Again, *this rating is limited by the diode junction's thermal capacity*, and is usually much higher than the average current rating due to thermal inertia (the fact that it takes a finite amount of time for the diode to reach maximum temperature for a given current). Ideally, this figure would be infinite.



## Contd.

- Maximum total dissipation = P<sub>D</sub> The amount of power (in watts) allowable for the diode to dissipate, given the dissipation (P=IE) of diode current multiplied by diode voltage drop, and also the dissipation (P=I<sup>2</sup>R) of diode current squared multiplied by bulk resistance.
  *Fundamentally limited by the diode's thermal capacity* (ability to tolerate high temperatures).
- Operating junction temperature = T<sub>J</sub> The maximum allowable temperature for the diode's PN junction, usually given in degrees Celsius (°C). Heat is the "Achilles' heel" of semiconductor devices: they *must* be kept cool to function properly and give long service life.


# Contd.

- Typical junction capacitance = C<sub>J</sub> the typical amount of capacitance intrinsic to the junction, due to the depletion region acting as a dielectric separating the anode and cathode connections. This is usually a very small figure, measured in the range of picofarads (pF).
- Reverse recovery time = t<sub>rr</sub> the amount of time it takes for a diode to "turn off" when the voltage across it alternates from forward-bias to reverse-bias polarity. Ideally, this figure would be zero



# Power Supply



EN 202 Electronics



# Need of Filter

- Full-wave rectifier output is not smooth, it has lot of ripples
- In order to minimize these ripples, a filter is required to smooth the out of full wave rectifier.



## Shunt Capacitor Filter

- Shunt capacitor is simplest and cheapest type filter
- Connect a large value of capacitor across load
- Block DC, allow AC to follow
- Rate of discharge depend on R<sub>L</sub>C
- Large C give less ripples
- Upper limit of C depends on current handling rating of diodes





### Conduction angle of diode



**EN 202 Electronics** 



# Ripple voltage

$$V = \frac{Q}{C} \qquad \qquad V_1 = \frac{Q_1}{C}$$

$$V_2 = \frac{Q_2}{C}$$

$$V_1 - V_2 = \frac{Q_1 - Q_2}{C}$$

$$\frac{V_1 - V_2}{T_1 - T_2} = \frac{Q_1 - Q_2}{C(T_1 - T_2)}$$

$$\frac{V_1 - V_2}{T} = \frac{Q_1 - Q_2}{CT}$$

$$\frac{V_1 - V_2}{T} = \frac{I}{C}$$

$$V_{rip} = \frac{I}{fC}$$

$$V_{rip}$$
 = peak-to-peak ripple voltage  
 $I$  = dc load current

- f = ripple frequency
- C = capacitance

$$V_{dc} = V_{2(peak)} - \frac{V_{rip}}{2}$$

EN 202 Electronics



# Problem

Load current = 10 mA Capacitance= 470  $\mu$ F Line frequency = 50 Hz

Find ripple voltage of full wave rectifier and half wave rectifier



# Need of Regulator

- Output of filter also have some ripples, to make it more smooth, regulator is required.
- Zener diode is one of the simplest type of regulator





#### Zener diodes



EN 202 Electronics



A zener diode with a power rating of 0.5 watt would be adequate, as would a resistor rated for 1.5 or 2 watts of dissipation.





# Contd.



$$P_{resistor} = (324 \,\mu A)(32.4V)$$

$$P_{resistor} = 10.498 mW$$

$$P_{diode} = (324 \,\mu A)(12.6V)$$

$$P_{diode} = 4.0824 mW$$

$$P_{diode} = 4.0824 mW$$

EN 202 Electronics



**EN 202 Electronics** 



# Schottky diodes

- Schottky diodes are constructed of a metal-to-N junction rather than a P-N semiconductor junction.
- Schottky diodes are characterized by fast switching times (low reverserecovery time), low forward voltage drop (typically 0.25 to 0.4 volts for a metal-silicon junction), and low junction capacitance. This makes them *well suited for high-frequency applications*.
- In terms of forward voltage drop (V<sub>F</sub>), reverse-recovery time (t<sub>rr</sub>), and junction capacitance (C<sub>J</sub>), Schottky diodes are closer to ideal than the average "rectifying" diode. Unfortunately, though, *Schottky diodes typically have lower forward current (I<sub>F</sub>) and reverse voltage (V<sub>RRM</sub> and V<sub>DC</sub>)* ratings than rectifying diodes and are thus unsuitable for applications involving substantial amounts of power.



#### Tunnel diodes

- Tunnel diodes exploit a strange quantum phenomenon called resonant tunneling to provide interesting forwardbias characteristics having peak current (I<sub>P</sub>) Valley current (I<sub>V</sub>).
- Able to transition between peak and valley current levels very quickly, "switching" between high and low states of conduction much faster than even Schottky diodes.
- Tunnel diode characteristics are also relatively unaffected by changes in temperature.



**EN 202 Electronics** 



# Light-emitting diodes

- Some semiconductor junctions, composed of special chemical combinations, emit radiant energy within the spectrum of visible light as the electrons transition in energy levels.
- Simply put, these *junctions glow when forward biased*. A diode intentionally designed to glow like a lamp is called a *lightemitting diode*, or *LED*.
- Diodes made from a combination of the elements *gallium, arsenic, and phosphorus* (called *gallium-arsenide-phosphide*) glow bright red, and are some of the most common LEDs manufactured





### Varactor Diode

- It is operated reverse-biased so no current flows through it, but since the width of the depletion region varies with the applied bias voltage, the capacitance of the diode can be made to vary.
- Varactors are commonly used in voltage-controlled oscillators







# Limiter

# Limiter removes signal voltage above and below a specified level

- Useful for signal shaping, circuit protection etc.
- Use of small signal diode at high frequency.



## **Positive Limiter**



EN 202 Electronics



## **Biased limiter**



EN 202 Electronics



## **Combination limiter**



EN 202 Electronics



## Circuit protection limiter



**EN 202 Electronics** 



#### Transistors

EN 202 Electronics



## Introduction

- The invention of the bipolar transistor in 1948 ushered in a revolution in electronics.
- Bipolar transistors consist of either a P-N-P or an N-P-N semiconductor "sandwich" structure.
- The three leads of a bipolar transistor are called the *Emitter*, *Base*, and *Collector*.
- Difference between PNP and NPN transistor is the proper biasing of junctions. Current directions and voltage polarities for each type of transistor are exactly opposite



EN 202 Electronics



#### Transistor Mode of Operation

Condition	Emitter junction	Collector junction	Region of operation
FR	Forward-biased	Reverse-biased	Active
FF	Forward-biased	Forward-biased	Saturation
RR	Reverse-biased	Reverse-biased	Cutoff
RF	Reverse-biased	Forward-biased	Inverted

Biasing an NPN transistor for active operation



**EN 202 Electronics** 



#### Only emitter junction forward biased



- Larger current flow
- ~ 99 % of total current carried by electrons (moving from emitter to base)
- Emitter current and base current very large  $(I_E = I_B)$ ,  $I_C = 0$



#### Only collector junction reverse biased



- Very small current flow (minority carrier current temperature dependent current) called collector leakage current I<sub>CBO</sub>
- I<sub>CBO</sub> signifies current between collector and base when third terminal (emitter) is open



# Surprising action of transistor

If emitter junction forward biased and collector junction reverse biased

- Expectation
  - Both emitter and base current to be large and collector current very small
- Reality
  - Emitter current is large as expected, but base current turns out to be very small and collector current turns out to be large



# Working of transistor



- Ratio of no. of electrons arriving at collector to no. of emitted electrons is know as base transportation factor (typically ~ 0.99)
- No. of electrons (like 3) and holes (like 7) crossing the E-B junction is much more than the no. of electrons (like 5) and holes (like 8) crossing the C-B junction. The difference of these two currents is base current.



#### Contd.

- Collector current is less than emitter current
  - A part or emitter current consists of holes that do not contribute to collector current
  - Not all the electrons injected into the base are successful in reaching collector.

Ratio of collector current to emitter current is typically 0.99 denoted by  $\mathbf{a}_{\rm dc}$ 

- Collector current made up of two parts
  - Fraction of emitter current which reaches the collector
  - Reverse leakage current I<sub>co</sub>

$$I_C = \alpha_{dc} I_E + I_{CO}$$

Total current equation

$$I_E = I_C + I_B$$



# Problem

An NPN transistor has of a<sub>dc</sub> 0.98 and a collector leakage current of 1 uA. Calculate the collector and base current, when emitter current is 1 mA.



#### Transistor amplifying action



EN 202 Electronics



#### Different configurations of transistor



- Figure shows three configuration from ac point of view.
- In all configurations, emitter-base junction is always forwardbiased and collector base junction is always reverse-biased.



#### Transistor characteristics

Static characteristic curves to relate current and voltage in a transistor.

- Input characteristic
- Output characteristic





#### **Common-Base Input characteristics**



**EN 202 Electronics** 



#### **Common-Base output characteristics**



$$r_{o} = \frac{\Delta v_{CB}}{\Delta i_{C}} \Big|_{I_{E}} = Const.$$
$$h_{fb} or \alpha = \frac{\Delta i_{C}}{\Delta i_{E}} \Big|_{V_{CB}} = Const.$$

- High output resistance can be good current source
- Saturation region collector current not remain same with change in emitter current
- Cut-off region- collector current is not zero even emitter current is zero due to leakage current I<sub>CB0</sub> OR I<sub>C0</sub>



#### Summary of C-B characteristics

- Current gain slightly less then unity (~0.98)
- Dynamic input resistance very low (~ 20 ohm)
- Dynamic output resistance very high (~ 1 M ohm)
- Leakage current very low (~ 0.02 uA for Si transistor)


# C-E Configuration







 $I_C = \beta_{dc} I_B + I_{CEO}$ 

Mostly work in active region

**EN 202 Electronics** 



$$\beta_{dc} = \frac{\alpha_{dc}}{1 - \alpha_{dc}}$$

$$\beta_{dc} - \beta_{dc} \alpha_{dc} = \alpha_{dc}$$

$$\beta_{dc} = \alpha_{dc} (1 + \beta_{dc})$$

$$\alpha_{dc} = \frac{\beta_{dc}}{\beta_{dc} + 1}$$

$$I_E = I_C + I_B$$

$$\Delta i_E = \Delta i_C + \Delta i_B$$

$$\frac{\Delta i_E}{\Delta i_C} = 1 + \frac{\Delta i_B}{\Delta i_C}$$

$$\frac{1}{\alpha} = 1 + \frac{1}{\beta}$$

$$\beta = \frac{\alpha}{1 - \alpha}$$

EN 202 Electronics





#### C-E input characteristics





$$r_i = \frac{\Delta v_{BE}}{\Delta i_B} \mid V_{CE} = Const.$$

**EN 202 Electronics** 



**Rajesh Gupta** 

#### C-E output characteristics



- Current gain increase with Vce
- Small base current produce large change in collector current
- Large leakage current I<sub>CEO</sub>

EN 202 Electronics



#### Comparison between CB and CE

Pa	arameters	Common – base Configuration	Common – emitter Configuration
1.	Input dynamic resistance	Very low (20 Ω)	Low (1 kΩ)
2.	Output dynamic resistance	Very high (1 MΩ)	High (10 kΩ)
3.	Current gain	Less than unity (0.98)	High (100)
4.	Leakage current	Very small (5 μA for Ge, 1 μA for Si)	Very large (500 μA for Ge, 20 μA for Si)

Leakage current lead to Thermal Runway





### Problems

- When emitter current of transistor changed by 1mA, its collector current changed by 0.995 mA. Calculate
  - CB current gain
  - CE current gain
- The DC current gain of a transistor in CE configuration is 100. Find DC current gain in CB configuration.



#### Why CE configuration widely used



- A good amplifier stage is one which has high input resistance and low output resistance
- Current gain is more in CE configuration



#### **Common-collector configuration**



Emitter current as a function of base current

$$I_E = I_B + I_C$$
$$I_C = \alpha_{dc} I_E + I_{CBC}$$

**EN 202 Electronics** 



# Contd.

$$I_E = I_B + \alpha_{dc}I_E + I_{CBO}$$
$$(1 - \alpha_{dc})I_E = I_B + I_{CBO}$$
$$I_E = \frac{1}{1 - \alpha_{dc}}I_B + \frac{1}{1 - \alpha_{dc}}I_{CBO}$$
$$\frac{1}{1 - \alpha_{dc}} = \beta_{dc} + 1$$
$$I_E = (\beta_{dc} + 1)I_B + (\beta_{dc} + 1)I_{CBO}$$

$$I_E = (\beta_{dc} + 1)I_B$$
$$\frac{I_E}{I_B} = (\beta_{dc} + 1)$$

EN 202 Electronics



## CC characteristics

- High input resistance (~ 150 k ohm)
- Low output resistance (~ 800 ohm)
- High current gain (~100)
- Low voltage gain (less then unity)



#### Transistor data sheet

#### Important parameters

- Maximum power dissipation
- Maximum allowable voltage
- Current gain
- Max frequency of operation



#### Basic CE amplifier circuit



**EN 202 Electronics** 



### DC load line



$$V_{CC} = I_C R_C + V_{CE}$$

$$I_C = \left(-\frac{1}{R_C}\right) V_{CE} + \frac{V_{CC}}{R_C}$$

$$y = mx + c$$

EN 202 Electronics



$$(i)V_{CE} = V_{CC}; \quad I_C = 0$$
$$(ii)V_{CE} = 0; \quad I_C = \frac{V_{CC}}{R_C}$$



#### Amplification and Q-point



**EN 202 Electronics** 



### Selection of Q-point





#### Logic Gate Using Transistor







### **Current regulator**

- Transistors function as current regulators by allowing a small current to control a larger current. The amount of current allowed between collector and emitter is primarily determined by the amount of current moving between baseand emitter.
- In order for a transistor to properly function as a current regulator, the controlling (base) current and the controlled (collector) currents must be going in the proper directions: meshing additively at the emitter and going *against* the emitter arrow symbol.





#### Transistor as a switch

- Transistor's collector current is proportionally limited by its base current, it can be used as a sort of current-controlled switch. A relatively small flow of electrons sent through the base of the transistor has the ability to exert control over a much larger flow of electrons through the collector
- When a transistor has zero current through it, it is said to be in a state of *cutoff*
- When a transistor has maximum current through it, it is said to be in a state of *saturation*.





### Inverter





Rajesh Gupta

EN 202 Electronics



# NOR Gate



EN 202 Electronics



# OR Gate



EN 202 Electronics



### AND Gate



EN 202 Electronics



#### NAND Gate

EN 202 Electronics



## XOR Gate

EN 202 Electronics



#### **Transistor Biasing Circuit**







#### Stabilization of Q-point

Requirement of biasing circuit

- Operating point in the centre of active region
- Stabilization of collector current against temperature variations
- Making operating point independent of transistor parameters



#### Different biasing techniques used for achieving these points

**EN 202 Electronics** 



#### Fixed Bias



**EN 202** Electronics



#### Steps for calculating Q-point in fixed bias

- 1. Calculate base voltage, in case  $V_{BE}$  is known, use more accurate calculation.
- 2. Calculate collector current from base current, make sure its not greater than  $I_{c(sat)}$
- 3. Calculate collector-emitter voltage



## Problem

Calculate the Q-point for the circuit given in figure







## Problem

- Calculate
  - Q-point in circuit. Given R<sub>C</sub>=1 k ohm and R<sub>B</sub>=100 k ohm
  - If transistor is replaced by another unit of beta=150 instead of 60. Determine its new Q-point.





# Assignment (1 Mark)

In a given circuit, a supply of 6 V and a load resistance of 1 k ohm is used.

- Find the value of resistance  $R_B$  so that a germanium transistor with  $\beta$ =20 and  $I_{CBO}$ =2uA draws an  $I_C$  of 1 mA.
- What Ic is drawn if the transistor parameters change to  $\beta$ =25 and I<sub>CBO</sub> = 10 uA due to rise in temperature ?





#### Fixed bias features

#### **Advantages**

- Very simple
- very few component
- Easy to fix Q point by changing R<sub>B</sub>

#### Limitations

- Thermal runway
- Strongly β dependent Q-point







#### Collector to base bias circuit

 $V_{CC} = R_C (I_C + I_B) + I_B R_B + V_{BE}$  $V_{CC} = R_C I_C + (R_C + R_B) I_B + V_{BE}$  $I_B = \frac{(V_{CC} - I_C R_C) - V_{BE}}{R_C + R_B}$ 

$$I_B = \frac{V_{CE} - V_{BE}}{R_C + R_B}$$





**EN 202** Electronics



# Contd.

$$V_{CC} = R_C \beta I_B + (R_C + R_B) I_B + V_{BE}$$
$$V_{CC} = V_{BE} + [R_B + (\beta + 1)R_C] I_B$$

 $I_B \sim Vcc/(R_B + \beta Rc)$ 

$$V_{CC} - (I_B + I_C)R_C - V_{CE} = 0$$
$$V_{CE} = V_{CC} - (I_C + I_B)R_C \cong V_{CC} - I_C R_C$$

Shift in Q-point due to change in  $\beta$  is not much as it occurs in case of fixed bias

EN 202 Electronics



#### Features of collector to base bias circuit

#### Advantages

- Check thermal runway
- Q-point less dependent on β value
  Limitations
- Base resistance also provide AC feedback, that reduce voltage gain



### Problem

Calculate the minimum and maximum collector current in the given circuit, if  $\beta$  varied with in the limit indicated.






## Bias circuit with emitter resistance





$$V_{CC} = R_{B}I_{B} + V_{BE} + I_{E}R_{E}$$
$$I_{B} = \frac{(V_{CC} - I_{E}R_{E} - V_{BE})}{R_{B}}$$

$$I_B \cong \frac{(V_{CC} - I_E R_E)}{R_B}$$



**EN 202 Electronics** 



$$V_{CC} = I_B R_B + V_{BE} + (\beta + 1) I_B R_E$$

$$I_B = \frac{V_{CC} - V_{BE}}{R_B + (\beta + 1)R_E} \cong \frac{V_{CC}}{R_B + \beta R_E}$$

$$I_{C} = \beta I_{B} = \frac{\beta V_{CC}}{R_{B} + \beta R_{E}} = \frac{V_{CC}}{R_{E} + (R_{B} / \beta)}$$

$$V_{CC} = I_C R_C + V_{CE} + I_E R_E$$
$$V_{CE} = V_{CC} - (R_C + R_E)I_C$$

EN 202 Electronics



### Features of bias circuit with emitter resistance

### Advantages

 Provide good stabilization of Q-point against temperature and β variation

### Limitations

- Emitter resistance provide a feedback causes reduction in voltage gain.
- For getting very good stabilization

$$R_E >> \frac{R_B}{\beta}$$

- For large R<sub>E</sub>, high DC source is required
- For small RB, low DC source is required



Problem: Calculate values of 3 currents



## Voltage divider biasing circuit



EN 202 Electronics



# Problem

### Find Q point



EN 202 Electronics



## Amplifiers

EN 202 Electronics



## DC Behavior



$$V_{CC} = I_C R_C + V_{CE} + I_E R_E$$

$$=V_{CE}+I_C(R_C+R_E)$$

$$I_{C} = \frac{-1}{(R_{C} + R_{E})} V_{CE} + \frac{V_{CC}}{(R_{C} + R_{E})}$$

EN 202 Electronics



## Input and Output phase



**EN 202 Electronics** 



## AC Behavior



AC equivalent

EN 202 Electronics



## **Transistor Equivalent Circuit**

Input

Output







**EN 202 Electronics** 



# Contd.







## h-Parameter

- Manufacture specify characteristics of a transistor in terms of *h* (hybrid) parameters
- Hybrid is used with these parameters because they are a mixture of constants having different units
- It becomes popular because they can be measure easily



## Transistor as two-port network



$$\upsilon_1 = h_{11}i_1 + h_{12}\upsilon_2$$
$$i_2 = h_{21}i_1 + h_{22}\upsilon_2$$

$$\begin{aligned} h_{11} &= \frac{\upsilon_1}{i_1} \middle|_{\upsilon_2 = 0} &= \text{Input impedance (with output shorted)} = h_i \\ h_{21} &= \frac{i_2}{i_1} \middle|_{\upsilon_2 = 0} &= \text{Forward Current ratio (with output shorted)} = h_f \\ h_{12} &= \frac{\upsilon_1}{\upsilon_2} \middle|_{i_1 = 0} &= \text{Reverse voltage ratio (with input open)} = h_r \\ h_{22} &= \frac{i_2}{\upsilon_2} \middle|_{i_1 = 0} &= \text{Output admittance (with input open)} = h_o \end{aligned}$$

EN 202 Electronics



## Hybrid equivalent circuit



EN 202 Electronics



## Amplifier analysis





**EN 202 Electronics** 



## Contd.

Current gain,  $A_i = \frac{Output Current}{Input Current} = \frac{i_c}{i_h}$  $=\frac{h_{fe}i_b}{i_b}=h_{fe}$  $A_p = A_i A_p$  $A_i = \beta$  $Z'_{in} = R_1 \parallel R_2 \parallel h_{ie} \cong h_{ie}$ Voltage gain,  $A_{v} = \frac{Output Voltage}{Input Voltage} = \frac{-h_{fe}i_{b}R_{ac}}{i_{b}h_{ie}}$  $Z'_o = (1/h_{oe}) \parallel R_{ac} \cong R_{ac}$  $= \frac{-h_{fe}R_{ac}}{h_{ie}}$  $A_{\upsilon} = \frac{\beta R_{ac}}{r_i} \angle 180^0$ 

**EN 202 Electronics** 



# Problem

Current Gain 150,  $R_{in}$ =2 k ohm

Calculate voltage gain and input impedance





## Multi-stage Amplifiers



$$A = \frac{D_o}{D_s} = \frac{D_1}{D_s} \times \frac{D_2}{D_1} \times \dots \times \frac{D_{n-1}}{D_{n-2}} \times \frac{D_o}{D_{n-1}}$$

$$A = A_1 \times A_2 \times \ldots \times A_{n-1} \times A_n$$

Numbers of bels =

 $Log10\frac{P2}{P1}$ 

**EN 202 Electronics** 



Number of dB = 10 × Number of bels = 10  $\log_{10} \frac{P_2}{P_1}$ 

Gain in dB = 20 
$$\log_{10} \frac{V_2}{V_1}$$

$$A_{dB} = A_{dB1} + A_{dB2} + \dots + A_{dBn}$$

EN 202 Electronics



# Why dB

- Simple addition of gain
- Permits us to denote very small and very large value
- Our hearing power in logarithmic



## Coupling of two stages

- Minimum loss of signal
- Should not affect biasing of other stage

## **Typical Couplings**

- RC coupling
- Transformer coupling
- Direct coupling



# RC coupling

- Widely used
- Makes DC biasing independent
- Not good for low frequency applications





## Transformer coupling

- DC isolation provided by transformer
- Bigger in size
- Does not amplify signals of different frequency equally
- Suited for power amplifiers and tuned voltage amplifiers





## Direct coupling

- Required at very low frequency
- Affect biasing of other stage (consider this while designing)



## Frequency response of Amplifier





EN 202 Electronics



# At low *f*

 Provide low gain due to high reactance of coupling capacitors





# At high *f*



EN 202 Electronics



# Contd.







## Bandwidth



$$0.707 \text{ A}_{\text{vm}} = 1 / \sqrt{2} \text{ A}_{\text{vm}}$$

EN 202 Electronics



### Effect on band width with no. of stages

- Bandwidth decreases with increase in no. of stages
  - Because greater no. of capacitor in the circuit
- Voltage gain

$$A'_{\upsilon} = (A_{\upsilon m})^n$$

Upper and lower cut of frequency

$$f' 1 = \frac{1}{\sqrt{(2^{1/n} - 1)}} f 1$$
$$f 2 = \sqrt{(2^{1/n} - 1)} f 2$$



## Two-stage RC-coupled amplifier



EN 202 Electronics



#### Contd. $\stackrel{l_{b1}}{\longrightarrow} B_1$ C $B_{2}$ $C_{\gamma}$ *i*<sub>b 2</sub> $=R_1 \parallel R_2$ $\zeta_B = R_1 \parallel R_2$ $(\mathbf{v})$ $v_{s}$ $h_{ie}$ $R_{C1}$ $h_{_{ie}}$ $R_{ac}$ $h_{ie}i_{b2}$ $h_{ie}i_{b1}$ Е $R_{B} = R_{1} \parallel R_{2} = \frac{R_{1}R_{2}}{R_{1} + R_{2}}$ $h_{fe} R_{ac1}$ $A_1$ h<sub>ie</sub> $h_{fe}R_{ac2}$ $A_{2} =$ $A_{\upsilon m} = A_1 \times A_2$ $R_{ac2} = R_{C2} \parallel R_L = \frac{R_{C2}R_L}{R_{C2} + R_L}$ $A_1$ is always less than $A_2$ , because of lower $R_{ac1}$ due to loading effect

**EN 202 Electronics** 



# Problem

### Calculate

- input impedance
- output impedance
- voltage gain both transistor





## **Distortion in Amplifiers**

- When wave shape of the output is not an exact replica of input wave
- Caused by
  - Reactive component and non-linear characteristic of transistor
- Frequency distortion
  - Caused by electrode capacitance and other reactive components





# Contd.

- Phase distortion
  - Delay introduce by the amplifier is different for various frequency
  - Reactive components of the circuit are responsible for this distortion
- Harmonic distortion
  - Output contain new frequency components that are not present in the input. New frequency are harmonics of present in input
  - Happen due to non-linearity in the dynamic transfer characteristic curves



## Contd.





EN 202 Electronics


#### **Operational-Amplifiers**





# Introduction

- The operational amplifier is most useful single device in analog electronic circuitry.
- With only few external components, it can perform a wide variety of analog signal processing tasks.
- One key to the usefulness of these little circuits is in the engineering principle of feedback, particularly *negative* feedback, which constitutes the foundation of almost all automatic control processes.



### Single-ended

- A "shorthand" symbol for an electronic amplifier is a triangle, the wide end signifying the input side and the narrow end signifying the output.
- To facilitate true AC output from an amplifier, we use a *split* or *dual* power supply, with two DC voltage sources connected in series with the middle point grounded, giving a positive voltage to ground (+V) and a negative voltage to ground (-V).





# **Differential amplifiers**

Vo

- Most amplifiers have one input and one output. *Differential amplifiers* have two inputs and one output, the output signal being proportional to the difference in signals between the two inputs.
- The voltage output of a differential amplifier is determined by the following equation: V<sub>out</sub> = A<sub>V</sub>(V<sub>noninv</sub> V<sub>inv</sub>)



$(-)Input_1$	0	0	0	0	1	2.5	7	3	-3	-2
$(+)Input_2$	0	1	2.5	7	0	0	0	3	3	-7
Output	0	4	10	28	-4	-10	-28	0	24	-20

Itage output equation = 
$$V_{out} = A_V(Input_2 - Input_1)$$
  
OR  
 $V_{out} = A_V(Input_{(+)} - Input_{(-)})$ 

**EN 202 Electronics** 



### The "operational" amplifier

- High-gain differential amplifiers came to be known as *operational amplifiers*, or *op-amps*, because of their application in analog computers' mathematical *operations*.
- *Op-amp* have extremely high voltage gain ( $A_V = 200,000$  or more).
- Long before computers were built to electronically perform calculations by employing voltages and currents to represent numerical quantities.

$$i_{c} = C \frac{dv}{dt}$$
Where,
$$F = m \frac{dv}{dt}$$
Where,
$$i_{c}$$
 = Instantaneous current through capacitor
$$C = Capacitance in farads$$

$$\frac{dv}{dt} = Rate of change of voltage over time$$

$$F = Force applied to object$$

$$m = Mass of object$$

$$\frac{dv}{dt} = Rate of change of voltage over time$$

 Op-amps typically have very high input impedances and fairly low output impedances.

EN 202 Electronics



# **Op-amp electrical model**



**EN 202 Electronics** 



# Comparator





EN 202 Electronics



# Moving trip point











**EN 202 Electronics** 



# Schmitt Trigger

- Comparator contain noise, output may be erratic when input voltage is near to trip point
  - Noise causes output to jump back and forth between low and high states

#### Noise triggering can be avoided by schmitt trigger



Difference between UTP and LTP is called hysteresis, required to prevent false triggering due to noise

**EN 202 Electronics** 



### Moving trip point of schmitt trigger



**EN 202 Electronics** 



# Problem

#### Find UTP and LTP

- Given
- Vcc= 12 V, Vee=-12V, R2=R3=2 k ohm, R1= 100 k ohm





## Sine to square waveform





 $-V_{sat}$ 

EN 202 Electronics



# **Relaxation oscillator**





$$T = 2RC \ln \frac{1+B}{1-B}$$

$$T =$$
 period of output signal  $R =$  feedback resistance

$$C = capacitance$$

B = feedback fraction,

EN 202 Electronics



## Counter based A/D convertor



**EN 202 Electronics** 



# **OP-AMP IC's**

#### Most popular 741



**EN 202 Electronics** 



# Comparator

#### To compare two voltages

 Op-amps are used as signal *comparators*, operating in full cutoff or saturation mode depending on which input (inverting or non-inverting) has the greatest voltage.



**EN 202 Electronics** 



#### Pulse width modulation by comparator

One comparator application is *pulse-width modulator*, and is made by comparing a sine-wave AC signal against a DC reference voltage. As the DC reference voltage is adjusted, the square-wave output of the comparator changes its duty cycle (positive versus negative times). Thus, the DC reference voltage controls, or *modulates* the pulse width of the output voltage.



**EN 202 Electronics** 



## Analog to digital convertor



**EN 202 Electronics** 



# Analog to digital convertor



	Comparator for level							Binary output		
Input voltage	$C_{1}$	$C_2$	$C_{3}$	$C_4$	$C_{5}$	$C_{6}$	$C_7$	$2^{2}$	2 <sup>1</sup>	$2^{0}$
0 to <i>V</i> /8	Low	Low	Low	Low	Low	Low	Low	0	0	0
V/8 to V/4	High	Low	Low	Low	Low	Low	Low	0	0	1
<i>V</i> /4 to <i>3V</i> /8	High	High	Low	Low	Low	Low	Low	0	1	0
<i>3V/8</i> to <i>V/2</i>	High	High	High	Low	Low	Low	Low	0	1	1
V/2 to 5V/8	High	High	High	High	Low	Low	Low	1	0	0
5V/8 to 3V/4	High	High	High	High	High	Low	Low	1	0	1
<i>3V</i> /4 to 7 <i>V</i> /8	High	High	High	High	High	High	Low	1	1	0
7V/8 toV	High	High	High	High	High	High	High	1	1	1

**EN 202 Electronics** 



# Negative feedback

- Connecting the output of an op-amp to its inverting (-) input is called *negative feedback*.
- When the output of an op-amp is *directly* connected to its inverting (-) input, a *voltage follower* will be created. Whatever signal voltage is impressed upon the noninverting (+) input will be seen on the output.
- An op-amp with negative feedback will try to drive its output voltage to whatever level necessary so that the differential voltage between the two inputs is practically zero. The higher the op-amp differential gain, the closer that differential voltage will be to zero.



**EN 202** Electronics



#### Divided feedback

#### Non-inverting Amplifier

A negative-feedback op-amp circuit with the input signal going to the noninverting (+) input is called a *noninverting amplifier*. The output voltage will be the same polarity as the input. Voltage gain is given by the following equation:  $A_V = (R_2/R_1) + 1$ 





# Contd.

#### **Inverting Amplifier**

A negative-feedback op-amp circuit with the input signal going to the "bottom" of the resistive voltage divider, with the noninverting (+) input grounded, is called an *inverting amplifier*. Its output voltage will be the opposite polarity of the input. Voltage gain is given by the following equation:  $A_V = R_2/R_1$ 



**EN 202 Electronics** 



# Average circuit





**EN 202 Electronics** 



# Summer circuit

- A summer circuit is one that sums, or adds, multiple analog voltage signals together. There are two basic varieties of op-amp summer circuits: noninverting and inverting.
- Summer circuits are quite useful in analog computer design.



**EN 202** Electronics



## **Differentiator circuits**

*Differentiator* produces a voltage output proportional to the input voltage's rate of change.

Applications: analog computation, process control



**EN 202 Electronics** 



# Integrator circuits

*integrator* produces a voltage output proportional to the product (multiplication) of the input voltage and time Applications: analog computation, process control



$$\frac{dv_{out}}{dt} = -\frac{V_{in}}{RC}$$
OR
$$V_{out} = \int_{0}^{t} -\frac{V_{in}}{RC} dt + c$$
Where,
C=Output voltage at start time (t=0)

**EN 202 Electronics** 



#### Voltage-to-current signal conversion

- Voltage signals are relatively easy to produce directly from transducer devices, whereas accurate current signals are not.
- DC current signals are often used in preference to DC voltage signals as analog representations of physical quantities. Current in a series circuit is absolutely equal at all points in that circuit regardless of wiring resistance, whereas voltage in a parallel-connected circuit may vary from end to end because of wire resistance.





# Slew rate

#### Maximum rate of output voltage change

$$i = C\frac{dv}{dt}$$

$$\frac{dv}{dt} = \frac{i}{C}$$

$$\frac{dv_{out}}{dt} = \frac{I_{\max}}{C_c}$$

$$\frac{dv_{out}}{dt} = \frac{60\,\mu A}{30\,pF} = 2\,V\,/\,\mu s$$







# Slew rate distortion





EN 202 Electronics



### Frequency response of Op-amp

- Directly coupled amplifier
- Gain bandwidth product constant





# **Op-amp Models and circuits**





## 555 Timer

EN 202 Electronics



# 555 Timer





EN 202 Electronics



## Monostable Operation





**EN 202** Electronics



# **Astable Operation**



**EN 202 Electronics**


#### Voltage control Oscillator





**EN 202 Electronics** 



#### **Active Filter**

EN 202 Electronics



#### Active filters

Frequency selective switch that passes a specified band of frequency and blocks/attenuates signals of frequency outside

- Analog or digital
- Passive or active
- Audio (AF) or radio frequency (RF)





#### Analog Active-RC (audio) filter

Active filter advantage

- Gain frequency adjustment
- No loading problem
- Cost



#### Commonly used filters

- Low pass filter
- High pass filter
- Band pass filter
- Band reject filter





**EN 202 Electronics** 



#### Classification of active filter

- Butterworth
  - Flat passband and flat stopband
- Chebyshev
  - Ripple passband and flat stopband
- Cauer
  - Ripple passband and ripple stopband





#### First order low pass butterworth filter



$$j = \sqrt{-1}$$
 and  $-jX_c = \frac{1}{j2\pi fC}$ 

$$V_1 = \frac{V_{in}}{1 + j2\pi fRC}$$



$$V_o = \left(1 + \frac{R_F}{R_1}\right) \frac{V_{in}}{1 + j2\pi f RC}$$

$$\frac{\upsilon_o}{\upsilon_{in}} = \frac{A_F}{1 + j(f / f_H)}$$

**EN 202 Electronics** 





## Problem

#### Design a low pass filter at a cut off frequency of 1 kHz with a pass band gain of 2





#### Second order low pass butterworth filter



**EN 202 Electronics** 



## Problem

#### Design a second order low pass filter at high cutoff frequency of 1 kHz.





#### First order high-pass butterworth filter



**EN 202 Electronics** 



## Problem

#### Design a high-pass filter at cutoff frequency of 1 kHz with a pass-band gain of 2



#### Second order high-pass butterworth filter



*Where*  $A_F = 1.586 =$  Passband gain for the second order Butterworth

- f = frequency of the input signal (Hz)
  - $f_L = \text{low cutoff frequency (HZ)}$

**EN 202** Electronics



#### Higher order filter: Third order low pass



EN 202 Electronics



#### Fourth order low pass



- Size increase
- accuracy decrease
- gain fixed limitation

**EN 202** Electronics



## Contd.



EN 202 Electronics



### Band pass filter

Two types (based on Q factor)

- Wide band pass (Q<10)</p>
- Narrow band pass (Q>10)

$$Q = \frac{f_C}{BW} = \frac{f_C}{f_H - f_L}$$

$$f_C = \sqrt{f_H f_L}$$





#### Wide band-pass filter



$$\left| \frac{\upsilon_{o}}{\upsilon_{in}} \right| = \frac{A_{FT}(f / f_{L})}{\sqrt{[1 + (f / f_{L})^{2}][1 + (f / f_{H})^{2}]}}$$

**EN 202 Electronics** 



## Problem

Design a wide band-pass filter with  $f_L$ = 200 Hz and  $f_H$  = 1 KHz, and a pass band gain of 4. calculate value of Q for the filter.



**EN 202 Electronics** 



## Band reject filter

Two types (based on Q factor)

Wide band reject (Q<10)</p>

Narrow band reject (Q>10) (notch filter)

$$Q = \frac{f_C}{BW} = \frac{f_C}{f_H - f_L}$$

$$f_C = \sqrt{f_H f_L}$$







## Contd.



EN 202 Electronics



#### Wide band reject filter requirement

- Low cut of frequency of high pass filter must be larger than high cutoff frequency of low pass filter
- Pass band gain of both high pass and low pass must be equal



### Problem

# Design a wide band reject filter with $f_L = 1 \text{ kHz}$ and $f_H = 200 \text{ Hz}$







#### Field Effect Transistor (FET)

EN 202 Electronics



#### Introduction

- Developed in 1960's
- Operation depend on majority carrier (unipolar transistor)
- Category
  - Junction FET (JFET)
  - Insulated gate FET (IGFET)
  - Metal oxide semiconductor (MOSFET)
- Advantages
  - High input impendence (~100 M ohm typical), where BJT typical value 2 k ohm
  - Easier to fabricate (suited for IC's)
  - Provide greater thermal stability compared to BJT
  - Less noisy than BJT and thus more suitable for input stage of low level amp.
  - Relatively immune to radiation, but BJT is very sensitive
- Disadvantage
  - Small Gain-bandwidth of device compared to BJT
  - Greater susceptibility to damage in handling



# JFET







EN 202 Electronics



## JFET biasing



**EN 202 Electronics** 



#### Drain source characteristics



EN 202 Electronics



## Contd.









#### Transfer characteristics



$$I_D = I_{DSS} \left( 1 - \frac{V_{GS}}{V_P} \right)^2$$

$$V_{GS} = 0 \text{ V}$$
$$I_D = I_{DSS}$$

$$I_D = 0, V_{GS} = V_P$$

**EN 202 Electronics** 



## Problem

 Determine the drain current of an n-channel JFET having pinch off voltage Vp = -4 V and drain-source saturation current I<sub>DSS</sub> = 12 mA at the following gatesource voltages

• 
$$V_{GS} = 0 V_{,} -1.2 V \text{ and } -2 V$$



#### **Plotting JFET Characteristics**









2

 $I_D$ 

 $I_{DSS}$ 

 $\frac{I_{DSS}}{2}$ 

 $\frac{I_{DSS}}{4}$ 

0

Contd.

$V_{GS}$	$I_D$ [=	$10 \text{ mA}(1 - \frac{V_{GS}}{-5 \text{ V}})^2]$	$L(m\Lambda)$		$I_D = I_{DSS}$	$1 - \frac{V_{GS}}{V}$
(V)	(mA)		$I_D$ (IIIA)			v <sub>P</sub> )
0	10	7	$P = 10  \longleftarrow I_{DSS}$			
-1	6.4	/ -	8		V	
-2 -3	3.6 1.6	×	6	-	V GS	
-4 -5	0.4		Λ		0.21/	I
			т О		$0.3V_P$	-
			2		$0.5V_P$	<u> </u>
	-5 -4 -3	-2 -1 (	$\rightarrow V_{cs}$ (Volts)		$V_P$	(
	$\uparrow$		U3 × /			
	$V_P$					

EN 202 Electronics



### JFET Parameters

- Drain source saturation current (I<sub>DSS</sub>) current at which the channel pinch off when gate-source shorted (V<sub>GS</sub>=0)
- Pinch-off voltage V<sub>P</sub>=V<sub>GS(off)</sub> gate source voltage at which drain source channel cut off or pinched off resulting no drain current
- Dynamic drain resistance (r<sub>d</sub>): ratio of small change in drain voltage to the small change in drain current, keeping gate voltage constant

$$r_d = \frac{\Delta v_{DS}}{\Delta i_D} \bigg|_{V_{GS}} = \text{const}$$

 Mutual conductance or transconductance (g<sub>m</sub>): ratio of small change in drain current to the small change in gate voltage, keeping the drain voltage constant

$$g_m = \frac{\Delta i_D}{\Delta v_{GS}} \bigg|_{V_{DS}} = \text{const.}$$



### JFET Fixed Biasing



$$V_{GS} = V_G - V_S = V_{GG} - 0 = V_{GG}$$

$$I_D = I_{DSS} \left( 1 - \frac{V_{GS}}{V_P} \right)^2$$

$$V_D = V_{DD} - I_D R_D$$

**EN 202** Electronics


## Problem

 Find drain current and drain source voltage







## Graphical approach



**EN 202 Electronics** 





**EN 202 Electronics** 



## Contd.



For 
$$I_D = 0$$
:  $V_{GS} = (O)R_S = 0$  V

For 
$$V_{GS} = V_P$$
:  $I_D = \frac{-V_P}{R_S}$ 

EN 202 Electronics



## Problem

#### Determine the value of V<sub>GS</sub> and I<sub>D</sub>



**EN 202 Electronics** 



EN 202 Electronics



#### Voltage divider bias



$$V_{G} = \frac{R_{G2}}{R_{G1} + R_{G2}} V_{DD}$$

$$V_{GS} = V_G - V_S = V_G - I_D R_S$$

#### **EN 202 Electronics**



## Problem

#### Determine the bias current in the circuit



**EN 202 Electronics** 



#### Ans





$$\begin{array}{c}
 I_D(mA) & V_{GS}(V) \\
 0 & 1.82 \\
 1.21 & 0
 \end{array}$$

EN 202 Electronics



#### Oscillators

EN 202 Electronics



## Sinusoidal oscillator

Oscillator is an amplifier which have positive feedback to supply own inputs voltage

- Requirement
- Need a positive feedback (with a resonant circuit)
- Loop gain should be unity

$$V_{out} = A v_{in}$$
  
 $V_f = AB v_{in}$ 



EN 202 Electronics



#### Contd. А Vout В Im AB < 1AB > 1AB=1

Initially, AB greater than one, as voltage build up, AB automatically decrease to 1 Starting Voltage : Noise

EN 202 Electronics



## Wien bridge oscillator

- For low to moderate frequencies (5Hz to 1 M Hz)
- Uses a feedback circuit called lead leg network





#### Lead-lag network



**EN 202 Electronics** 



#### Practical circuit

- Initially tungsten lamp has low resistance
- As oscillation build up resistance increases and gain reaches to 3, then oscillation stabilize which stablize tungsten lamp resistance

$$A_{CL} = \frac{R_1}{R_2} + 1 = \frac{2R'}{R'} + 1 = 3$$



**EN 202** Electronics



EN 202 Electronics



#### **Regulated Power Supplies**





#### Introduction

#### Requirements

- Output voltage constant despite relatively large changes in line voltage and load current
- Temperature stability
- Variable level of voltages



#### Voltage feedback regulation

- Use Zener diode as reference
- Keep the voltage constant even input voltage and load current change due to feedback mechanism

$$B \cong \frac{R_2}{R_1 + R_2}$$

$$V_F = V_Z + V_{BE}$$

$$BV_{out} = V_Z + V_{BE}$$

$$V_{out} = \frac{V_Z + V_{BE}}{B}$$



**EN 202 Electronics** 



#### Power dissipation in pass transistor

$$P_D = V_{CE} I_C$$

 $V_{CE}$  = collector – emitter voltage,  $V_{in} - V_{out}$ 

 $I_C = load current plus divider current$ 

- When load current is heavy pass transistor has to dissipate lot of power
- Sometime cooling is required



## **Current limiting**

- Series regulator has no short circuit protection
- If accidently short the load terminals, we get an enormous load current that will destroy the pass transistor or a diode

$$V_{BE} = I_{SL}R_4$$
$$I_{SL} = \frac{V_{BE}}{R_4}$$

<sup>R</sup>₄ 1Ω  $R_{2}$  $Q_{\overline{3}}$  $\leq R_s$  $R_1$ + $V_{out}$  $\geq R_{r}$ + $\dot{V}_{in}$  $Q_1$  $R_{2}$ 

 $Q_2$ 

where  $I_{SL}$  = short – circuit load current

 $V_{BE}$  = base – emitter voltage, 0.6 to 0.7 V

 $R_4$  = current - sensing resistance

**EN 202** Electronics



#### Power supply characteristics

- Load regulation
- Source regulation
- Output Impedance
- Ripple Rejection



#### Fixed Regulator in market



**EN 202 Electronics** 



#### Modulation

EN 202 Electronics



## Introduction

Possible way to transmit speech and music

- Convert speech or music into electrical signal and transmit with a help of antenna.
- Receiver antenna can pick these signals and fed them to a loudspeaker to reproduce speech or music

#### Problem

- Energy of audio signal is low and can not be efficiently radiated. It will die out after covering even a small distance
- If different transmitting station make transmission simultaneously, receiver antenna will pick all the singnal and it will lead to confusion



# Contd.

#### Solution

 Audio signal superimposed on the high frequency carrier wave and then transmit. This process is called *modulation*.

The audio signal is called *modulating wave* and the signal obtained on superimposing it on carrier waves is called *modulated wave*, which is of high frequency



## Modulation types

Signal

Carrier

Amplitude modulated

Frequency modulated



EN 202 Electronics



#### Simple Amplitude Modulation



EN 202 Electronics



#### Example of amplitude modulated RF stage



**EN 202 Electronics** 



### Percent modulation

Sinusoidal modulating stage produce sinusoidal variation in voltage gain expressed by

 $A = A_0(1 + m\sin\omega_y t)$ 

A = instantaneous voltage gain  $A_0 =$  quiescent voltage gain

m =modulation coefficient

Voltage gain varies between  $A_0(1-m)$  and  $A_0(1+m)$   $A_{\min} = 100(1-0.5) = 50$ if  $A_0 = 100$  and m = 0.5 $A_{\max} = 100(1+0.5) = 150$ 

**EN 202 Electronics** 



#### Modulation percent

Percent modulation =  $m \times 100\%$ 



$$m = \frac{2V_{\text{max}} - 2V_{\text{min}}}{2V_{\text{max}} + 2V_{\text{min}}} \qquad m = \frac{16 - 4}{16 + 4} = 0.6$$







#### AM spectra

$$\upsilon_{out} = A\upsilon_x$$
$$\upsilon_{out} = AV_x \sin \omega_x t$$

 $\upsilon_{out} = A_0 (1 + m \sin \omega_y t) (V_x \sin \omega_x t)$ 

$$\upsilon_{out} = A_0 V_x \sin \omega_x t + m A_0 V_x \sin \omega_y t \sin \omega_x t$$

$$mA_0V_x\sin\omega_y t\sin\omega_x t = \frac{mA_0V_x}{2}COS(\omega_x - \omega_y)t - \frac{mA_0V_x}{2}COS(\omega_x + \omega_y)t$$



EN 202 Electronics

EN 202 Electronics

Rajesh Gupta



$$mA_0V_x\sin\omega_y t\sin\omega_x t = \frac{mA_0V_x}{2}\cos(\omega_x - \omega_y)t - \frac{mA_0V_x}{2}\cos(\omega_x + \omega_y)t$$

$$mA_0V_x\sin\omega_y t\sin\omega_x t = \frac{mA_0V_x}{2}\cos(\omega_x - \omega_y)t - \frac{mA_0V_x}{2}\cos(\omega_x + \omega_y)t$$

 $\upsilon_{out} = A_0 V_x \sin \omega_x t + m A_0 V_x \sin \omega_y t \sin \omega_x t$ 

$$mA_0V_x\sin\omega_y t\sin\omega_x t = \frac{mA_0V_x}{2}\cos(\omega_x - \omega_y)t - \frac{mA_0V_x}{2}\cos(\omega_x + \omega_y)t$$





#### Spectral components







EN 202 Electronics



#### Demodulation

- Envelop detector
  - Peak detector by diode







RC time constant function of m



EN 202 Electronics



# THE END Wish you all the best

EN 202 Electronics